MOSFET – Power, Single, N-Channel, SO-8 FL 30 V, 70 A

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- CPU Power Delivery
- DC-DC Converters

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Para	meter		Symbol	Value	Unit	
Drain-to-Source Volt	age		V _{DSS}			
Gate-to-Source Volta	age		V _{GS}	±20	V	
Continuous Drain Current R _{θJA} (Note 1)		T _A = 25°C T _A = 100°C	ID	17.1 10.9	A	
Power Dissipation R _{0JA} (Note 1)		T _A = 25°C	P _D	2.6	w	
Continuous Drain Current $R_{\theta JA} \leq 10 \text{ s}$ (Note 1)	Steady State	$T_{A} = 25^{\circ}C$ $T_{A} = 100^{\circ}C$	Ι _D	30 19	A	
Power Dissipation $R_{\theta JA} \le 10 \text{ s} \text{ (Note 1)}$		T _A = 25°C	P _D	8.1	W	
Continuous Drain Current R _{θJA} (Note 2)		$T_A = 25^{\circ}C$ $T_A = 100^{\circ}C$	Ι _D	10.2 6.5	A	
Power Dissipation $R_{\theta JA}$ (Note 2)		T _A = 25°C	P _D	0.92	W	
Continuous Drain Current R _{θJC} (Note 1)		$T_{\rm C} = 25^{\circ}{\rm C}$ $T_{\rm C} = 85^{\circ}{\rm C}$	Ι _D	70 44	A	
Power Dissipation $R_{\theta JC}$ (Note 1)		$T_{C} = 25^{\circ}C$	P _D	43	W	
Pulsed Drain Current	T _A = 25°	°C, t _p = 10 μs	I _{DM}	210	A	
Current Limited by Pa	ackage	$T_A = 25^{\circ}C$	I _{Dmax}	100	А	
Operating Junction an Temperature	nd Storage	•	T _J , T _{STG}	–55 to +150	°C	
Source Current (Body	Source Current (Body Diode)			40	Α	
Drain to Source DV/D	Drain to Source DV/DT			6.5	V/ns	
Single Pulse Drain-to-Source Avalanche Energy (T _J = 25°C, V _{DD} = 50 V, V _{GS} = 10 V, I _L = 37 A _{pk} , L = 0.1 mH, R _G = 25 Ω)			E _{AS}	68.5	mJ	
Lead Temperature for (1/8" from case for 10		Purposes	ΤL	260	°C	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

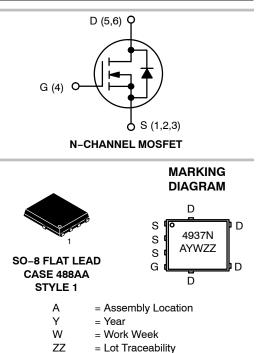
1. Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.



ON Semiconductor®

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	4.0 m Ω @ 10 V	70 A
30 V	6.0 mΩ @ 4.5 V	



ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4937NT1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel
NTMFS4937NT3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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2. Surface-mounted on FR4 board using the minimum recommended pad size.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{\theta JC}$	2.9	
Junction-to-Ambient - Steady State (Note 3)	R_{\thetaJA}	48	°C 444
Junction-to-Ambient - Steady State (Note 4)	R_{\thetaJA}	135	°C/W
Junction-to-Ambient – (t \leq 10 s) (Note 3)	R_{\thetaJA}	14.8	

Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
Surface-mounted on FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		30			V
Drain-to-Source Breakdown Voltage (transient)	V _{(BR)DSSt}	V_{GS} = 0 V, $I_{D(aval)}$ = 15.5 A, T_{case} = 25°C, $t_{transient}$ = 100 ns		34			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				15		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 24 V	$T_J = 25^{\circ}C$			1.0	
			T _J = 125°C			10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS}	= ±20 V			±100	nA

ON CHARACTERISTICS (Note 5)

Gate Threshold Voltage	V _{GS(TH)}	$V_{GS}=V_{DS},I_{D}=250\;\mu A$		1.32	1.63	2.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A		3.2	4.0	
			I _D = 15 A		3.2		
		V _{GS} = 4.5 V	I _D = 30 A		4.8	6.0	mΩ
			I _D = 15 A		4.8		
Forward Transconductance	9 _{FS}	V _{DS} = 1.5 V, I _D	₀ = 15 A		37		S

CHARGES, CAPACITANCES & GATE RESISTANCE

Input Capacitance	C _{ISS}		2516		
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 15 V	840		pF
Reverse Transfer Capacitance	C _{RSS}		25		
Capacitance Ratio	C _{RSS} / C _{ISS}	V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz	0.010	0.020	
Total Gate Charge	Q _{G(TOT)}		15.9		
Threshold Gate Charge	Q _{G(TH)}		4.0		nC
Gate-to-Source Charge	Q _{GS}	V _{GS} = 4.5 V, V _{DS} = 15 V; I _D = 30 A	7.6		nc
Gate-to-Drain Charge	Q _{GD}		2.2		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 15 V; I_{D} = 30 A	31		nC

SWITCHING CHARACTERISTICS (Note 6)

5. Pulse Test: pulse width \leq 300 µs, duty cycle \leq 2%. 6. Switching characteristics are independent of operating junction temperatures.

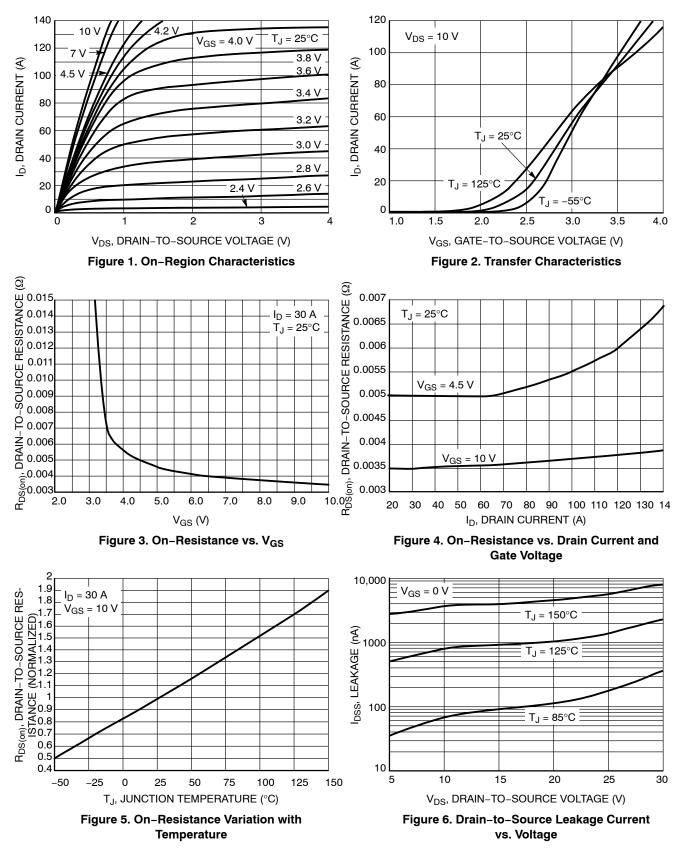
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS (N	lote 6)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 15 V, I _D = 15 A, R _G = 3.0 Ω			14.4		ns
Rise Time	t _r				25		
Turn-Off Delay Time	t _{d(OFF)}				23.4		
Fall Time	t _f				5.7		
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 15 V, I _D = 15 A, R _G = 3.0 Ω			10.6		
Rise Time	tr				21.1		- ns
Turn-Off Delay Time	t _{d(OFF)}				29.3		
Fall Time	t _f				4.0		
DRAIN-SOURCE DIODE CHARACT	ERISTICS			-			
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.88	1.1	
		$I_{\rm S} = 30 \rm A$	T _J = 125°C		0.78		- V
Reverse Recovery Time	t _{RR}				39		
Charge Time	t _a	V _{GS} = 0 V, dIS/dt	= 100 A/μs,		19		ns
Discharge Time	t _b	$I_{\rm S} = 30 {\rm A}$			20		1
Reverse Recovery Charge	Q _{RR}				35		nC
PACKAGE PARASITIC VALUES							
Source Inductance	L _S				0.93		nH
Drain Inductance	L _D				0.005		nH

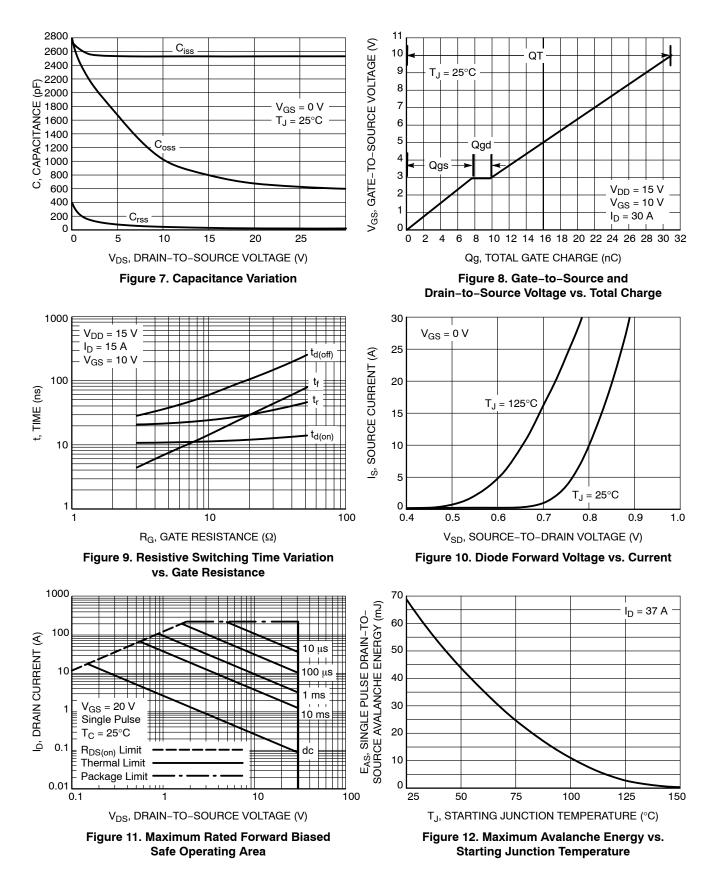
Source inductance	LS		0.93		nH
Drain Inductance	L _D	T 05°C	0.005		nH
Gate Inductance	L _G	T _A = 25°C	1.84		nH
Gate Resistance	R _G		1.1	2.0	Ω

5. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%. 6. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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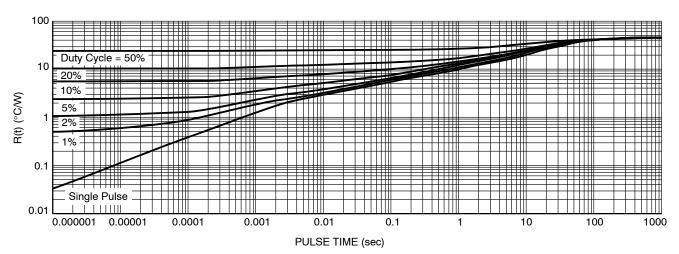
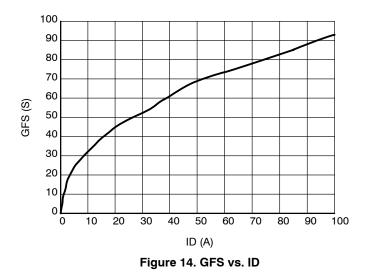


Figure 13. Thermal Response







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